

INFORMATION DISCLOSURE STATEMENT BY APPLICANT	ATTY. DOCKET NO. 52433/754	U.S. SERIAL NO. To Be Assigned
	APPLICANT H. OHISHI, et al.	

10/827,515

U. S. PATENT DOCUMENTS

DATE: April 19, 2004

EXAMINER INITIAL	PATENT NUMBER	PATENT DATE	NAME	CLASS	SUBCLASS	FILING DATE
OSP	4,476,274	October 9, 1984	LIU	524	445	
OSP	5,539,018	July 23, 1996	LUHMANN et al.	523	201	
OSP	4,607,075	August 19, 1986	BAUM et al.	524	449	
OSP	5,237,004	August 17, 1993	WU et al.	525	85	
OSP	4,219,628	August 26, 1980	WEEMES et al.	525	166	
OSP	4,629,750	December 16, 1986	HEPP	523	201	
OSP	4,659,767	April 21, 1987	DUNKLE et al.	524	504	
OSP	4,096,202	June 20, 1978	FARNHAM et al.	260	873	

FOREIGN PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
						YES	NO
OSP	0 256 391	February 24, 1988	EPO			English	
OSP	0 180 472	May 7, 1986	EPO			English	
OSP	0 472 418	February 26, 1992	EPO			English	
OSP	0 388 388	September 19, 1990	EPO			English	
OSP	0 653 461	May 17, 1995	EPO			English	
OSP	8-1864	January 9, 1996	Japan			Abstract	
OSP	62-91573	April 27, 1987	Japan			Abstract	
OSP	60-52179	January 18, 1985	Japan			Abstract	
OSP	59-30743	July 28, 1984	Japan				No
OSP	3-269074	November 29, 1991	Japan				No
OSP	7-195617	August 1, 1995	Japan				No
OSP	7-290643	November 7, 1995	Japan				No
OSP	7-290644	November 7, 1995	Japan				No
OSP	58-17148	February 1, 1983	Japan				No
OSP	5-186613	July 27, 1993	Japan				No
OSP	60-12233	March 30, 1985	Japan				No
OSP	63-13829	March 28, 1988	Japan				No

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